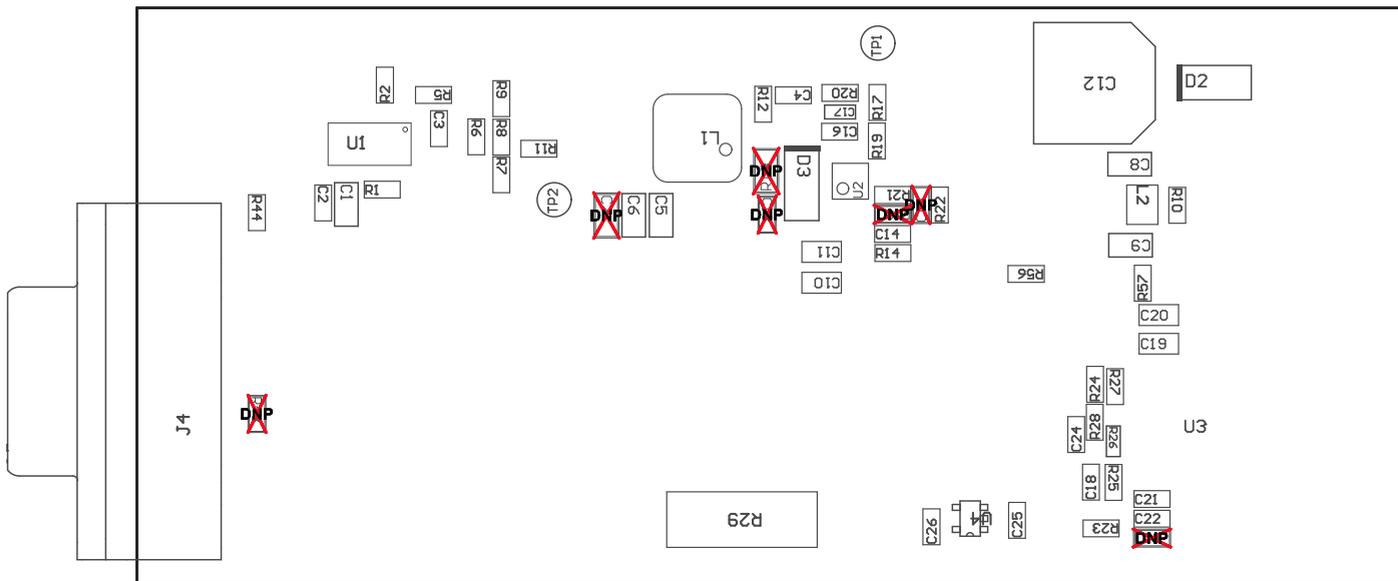


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: TIDA-00175_revE1

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00175	REV: E1	SUN REV: Not In VersionControl
IGNORE ->			
PLOT NAME = Top Assembly Drawing	GENERATED : 6/20/2014 7:35:14 PM	TEXAS INSTRUMENTS	



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: TIDA-00175_revE1

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00175	REV: E1	SVN REV: Not In VersionControl
	IGNORE ->		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 6/20/2014 7:35:16 PM	TEXAS INSTRUMENTS	

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